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Part Number: 0736443207

Status: Active

Overview: HDM Backplane Connector System

Description: HDM Board-to-Board Backplane Header, Vertical, SMC, Press-Fit, Guide Post Location

A, Polarizing Key Position D, 144 Circuits, Mating Length 6.00mm

Documents:

3D Model Packaging Specification PK-70873-0818 (PDF)

3D Model (PDF) RoHS Certificate of Compliance (PDF)

Drawing (PDF)

Agency Certification

CSA LR19980 UL E29179

General

Product Family Backplane Connectors

Series <u>73644</u> Application Backplane

Comments Standard Press-Fit, Tin/Lead (SnPb), Standard Press-

Fit, Tin/Lead (SnPb)

Component Type PCB Header

Overview HDM Backplane Connector System

Product Name HDM

UPC 800754833455

Physical

Polarized to PCB

Stackable

Circuits (Loaded) 144
Circuits (maximum) 144

Color - Resin Black, Natural

Durability (mating cycles max)

First Mate / Last Break

Flammability

Guide to Mating Part

Keying to Mating Part

Yes

Material - Metal Phosphor Bronze, Stainless Steel

Material - Plating Mating Gold Material - Plating Termination Tin

Material - Resin High Temperature Thermoplastic

No

Yes

Net Weight 9.729/g Number of Columns 24

Number of Pairs Open Pin Field

Number of Rows Orientation Vertical PC Tail Length 3.50mm PCB Locator No **PCB** Retention Yes PCB Thickness - Recommended 2.50mm Packaging Type Tube Pitch - Mating Interface 2.00mm Pitch - Termination Interface 2.00mm Plating min - Mating 0.762um Plating min - Termination 0.381um

Surface Mount Compatible (SMC)

Temperature Range - Operating

-55° to +105°C

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Series image - Reference only

EU ELV

Not Relevant

EU RoHS China RoHS

Compliant REACH SVHC Not Contained Per -ED/71/2019 (16 July 2019)

Halogen-Free Status

Low-Halogen

For more information, please visit Contact US

China ROHS Green Image
ELV Not Relevant
RoHS Phthalates Not Contained

Search Parts in this Series

73644 Series

Mates With

<u>73632</u> HDM+ Board-to-Board Daughtercard Receptacle. <u>73780</u> HDM Board-to-Board

Daughtercard Receptacle

Application Tooling | FAQ

Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

DescriptionProduct #Extraction Tool621001000Backplane Insertion621001400

Signal Contact Tool

Backplane Insertion 622005703

Head for 144 Circuits

Termination Interface: Style Through Hole - Compliant Pin

Electrical

Current - Maximum per Contact1.0AData Rate1.0 GbpsReal Signals (per 25mm)75ShieldedNoVoltage - Maximum250V AC

Material Info

Reference - Drawing Numbers

Packaging Specification PK-70873-0818
Sales Drawing SDA-73644-XXXX

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